



IPC-4203B

Cover and Bonding Material for Flexible Printed Circuitry

Developed by the Flexible Circuits Base Materials Subcommittee (D-13)
of the Flexible Circuits Committee (D-10) of IPC

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Users of this standard are encouraged to participate in the
development of future revisions.

Contact:

IPC

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Cover and Bonding Material for Flexible Printed Circuitry

1 SCOPE

This standard establishes the classification system, the qualification and quality conformance requirements for dielectric films coated with an adhesive on one or both sides, which are to be used as cover material and/or bondply for flexible printed circuitry, and supported or unsupported adhesive films to be used in the fabrication of flexible printed circuitry. It does not cover non-flexible adhesives designed to be used in the rigid board areas of rigid flex constructions, which are covered in IPC-4101. Materials such as liquid-applied covercoat (see 3.1.8.3) are covered in IPC-SM-840 and are excluded from this document.

This specification supersedes both IPC-FC-232C and IPC-FC-233A and the requirements herein meet or exceed the requirements for Class 3 in these superseded documents. Note that conformance to Class 3 meets or exceeds conformance to Classes 1 and 2. IPC-4203 no longer utilizes the 3-class system.

1.1 Classification System The system described in 1.1.1 through 1.1.2.6 identifies adhesive coated dielectric films and flexible adhesive bonding films.

1.1.1 Nonspecific Designation A nonspecific designation is intended for use by designers on master drawings to designate their material choice. Further specification details may be indicated by using the specific designation in drawing notes and purchase documents. At the end of this standard is a series of material specification sheets designated by individual nonspecific designators. Each sheet outlines engineering and performance data for a flexible cover sheet and bonding film indicating base material type, adhesive type and method of reinforcement. The sheets are provided with a number for ordering purposes. For example, if a user wishes to order from specification sheet number 1, the number “1” would be substituted for the “S” in the designation example (i.e., IPC-4203/1).

Example of nonspecific designation: *IPC-4203/S* Where *S* is specification sheet number.

1.1.2 Specific Designation The specific designation **should** be as shown in the following example and is intended for use on purchase orders (see 6.1). The specific designation **should not** be used by designers on master drawings to indicate their material selection. Master drawings **shall** indicate the material design by the nonspecific designation, supplemented in notes with the material specification details as defined by the specific designation. This procedure is necessary because the specific designation is normally lengthy and will not fit the field for most computer cataloging.

NOTE: The alpha character “Z” replaces and is entirely equivalent to both the alpha character “N” (ref: Table 1-1) and the alpha character “N” (ref: Table 1-3) in the previous revision of this IPC standard. This interchange of alpha characters within the designation will help to alleviate confusion from using the alpha character “N” in both Tables 1-1 and 1-3 while retaining “N” in Table 1-5, Adhesive Type Designation, where “N” designates a Polyester Adhesive Type. Legacy designs that utilize a designation and material description from the original release of this IPC standard [alpha character “O” (from Table 1-1) and/or digit “0” (from Table 1-3)] may continue to be used. Supplier material certifications will reflect the current IPC standard’s revision, and accordingly, the alpha character “Z” in the designation.

Example of specific designation: *IPC-4203/S - C1E2M3/3*

Where:

IPC-4203/S - Nonspecific Designation (see 1.1.1)

C - Base Dielectric Type Designation (see 1.1.2.1)

1 - Reinforcement Method Designation (see 1.1.2.2)

E - Reinforcement Type Designation (see 1.1.2.3)

2 - Base Dielectric Thickness Designation (see 1.1.2.4)

M - Adhesive Type Designation (see 1.1.2.5)

3/3 - Adhesive Thickness Designation (see 1.1.2.6)

Note: The letter “X” **shall** be entered into the designation where an item is not specified (e.g., dielectric thickness).